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NX3V1T66

Low-ohmic single-pole single-throw analog switch

Rev. 7 — 2 November 2011

Product data sheet

1. General description

The NX3V1T66 is a low-ohmic single-pole single-throw analog switch. It has two input/output terminals (Y and Z) and an active HIGH enable input pin (E). When pin E is LOW, the analog switch is turned off.

Schmitt trigger action at the enable input (E) makes the circuit tolerant to slower input rise and fall times. A low input voltage threshold allows pin E to be driven by lower level logic signals without a significant increase in supply current I_{CC} . This makes it possible for the NX3V1T66 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.

The NX3V1T66 allows signals with amplitude up to V_{CC} to be transmitted from Y to Z or from Z to Y. Its ultra-low ON resistance (0.3 Ω) and flatness (0.1 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 0.8 Ω (typical) at $V_{CC} = 1.4 \text{ V}$
 - 0.5 Ω (typical) at $V_{CC} = 1.65 \text{ V}$
 - 0.3 Ω (typical) at $V_{CC} = 2.3 \text{ V}$
 - 0.25 Ω (typical) at $V_{CC} = 2.7 \text{ V}$
 - 0.25 Ω (typical) at $V_{CC} = 4.3 \text{ V}$
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A exceeds 7500 V
 - ♦ MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - ◆ IEC61000-4-2 contact discharge exceeds 6000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- Enable input accepts voltages above supply voltage
- 1.8 V control logic at V_{CC} = 3.6 V
- High current handling capability (500 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



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3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
NX3V1T66GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1				
NX3V1T66GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				

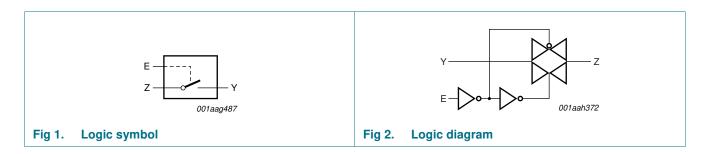
5. Marking

Table 2. Marking codes[1]

Type number	Marking code
NX3V1T66GW	dO
NX3V1T66GM	dO

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

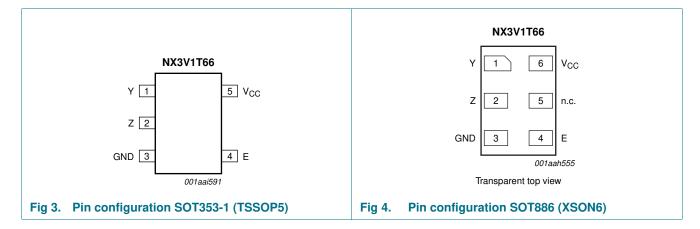
6. Functional diagram



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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT353-1	SOT886	
Υ	1	1	independent input or output
Z	2	2	independent output or input
GND	3	3	ground (0 V)
Е	4	4	enable input (active HIGH)
n.c.	-	5	not connected
V _{CC}	5	6	supply voltage

8. Functional description

Table 4. Function table[1]

Input E	Switch
L	OFF-state
Н	ON-state

^[1] H = HIGH voltage level; L = LOW voltage level.

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	enable input E	<u> 1</u> –0.5	+4.6	V
V_{SW}	switch voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mΑ
I _{SK}	switch clamping current	$V_{l} < -0.5 \text{ V or } V_{l} > V_{CC} + 0.5 \text{ V}$	-	±50	mΑ
I _{SW}	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current	-	±500	mA
		$V_{SW} > -0.5$ V or $V_{SW} < V_{CC} + 0.5$ V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±750	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C}$ to $+125 ^{\circ}\text{C}$	[3] _	250	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		1.4	4.3	V
V_{I}	input voltage	enable input E	0	4.3	V
V_{SW}	switch voltage		<u>[1]</u> 0	V_{CC}	V
T_{amb}	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	[2] _	200	ns/V

^[1] To avoid sinking GND current from of terminal Z when switch current flows in terminal Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Y. In this case, there is no limit for the voltage drop across the switch.

^[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

^[3] For TSSOP5 package: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

^[2] Applies to control signal levels.

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11. Static characteristics

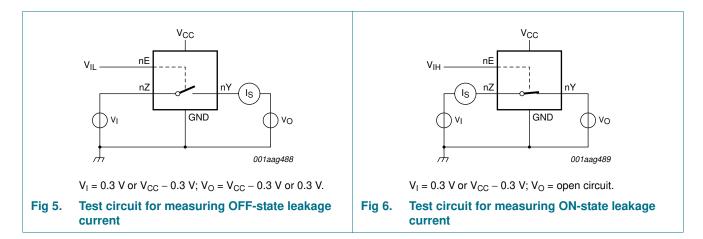
Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Tar	T _{amb} = 25 °C			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$		
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V_{IH}	HIGH-level	V _{CC} = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	٧
	input voltage	V _{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	٧
		V _{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		V _{CC} = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	٧
		V _{CC} = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	٧
V _{IL}	LOW-level	$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	-	0.3	-	0.3	0.3	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.5	-	0.5	0.5	V
		V _{CC} = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
l _l	input leakage current	enable input E; V_I = GND to 4.3 V; V_{CC} = 1.4 V to 4.3 V							
I _{S(OFF)}	OFF-state	Y port; see Figure 5							
	leakage current	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nΑ
	current	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nΑ
I _{S(ON)}	ON-state	Z port; see Figure 6							
	leakage current	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nΑ
	carrent	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$; $I_O = 0 \text{ A}$							
		V _{CC} = 3.6 V	-	-	100	-	690	6000	nΑ
		V _{CC} = 4.3 V	-	-	150	-	800	7000	nΑ
ΔI_{CC}	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μΑ
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μΑ
		$V_I = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	2.5	4.0	-	5	5	μΑ
		$V_I = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
C _I	input capacitance		-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	70	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	205	-	-	-	-	pF

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11.1 Test circuits



11.2 ON resistance

Table 8. Resistance R_{ON}

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

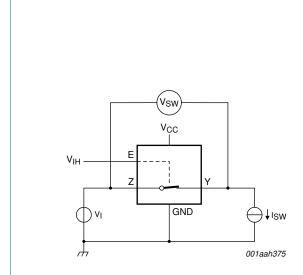
Symbol	Parameter	er Conditions		$T_{amb} = -40$ °C to +85		+85 °C	°C T _{amb} = -40 °C to +125 °C		
				Min	Typ[1]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}; \text{ see } \underline{Figure 7}$							
		V _{CC} = 1.4 V		-	8.0	1.9	-	2.1	Ω
		V _{CC} = 1.65 V		-	0.5	8.0	-	0.9	Ω
		V _{CC} = 2.3 V		-	0.3	0.5	-	0.6	Ω
		$V_{CC} = 2.7 \text{ V}$		-	0.25	0.45	-	0.5	Ω
		$V_{CC} = 4.3 \text{ V}$		-	0.25	0.45	-	0.5	Ω
$R_{ON(flat)}$	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	[2]						
		V _{CC} = 1.4 V		-	0.5	1.7	-	1.8	Ω
		V _{CC} = 1.65 V		-	0.25	0.6	-	0.7	Ω
		$V_{CC} = 2.3 \text{ V}$		-	0.1	0.2	-	0.2	Ω
		$V_{CC} = 2.7 \text{ V}$		-	0.1	0.2	-	0.2	Ω
		$V_{CC} = 4.3 \text{ V}$		-	0.1	0.25	-	0.25	Ω

^[1] Typical values are measured at T_{amb} = 25 $^{\circ}C.$

^[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

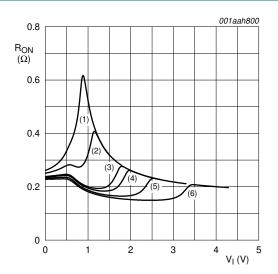
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11.3 ON resistance test circuit and graphs



 $R_{ON} = V_{SW} / I_{SW}$

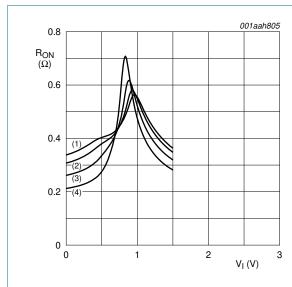
Fig 7. Test circuit for measuring ON resistance



- (1) $V_{CC} = 1.5 \text{ V}.$
- (2) $V_{CC} = 1.8 \text{ V}.$
- (3) $V_{CC} = 2.5 \text{ V}.$
- (4) $V_{CC} = 2.7 \text{ V}.$
- (5) $V_{CC} = 3.3 \text{ V}.$ (6) $V_{CC} = 4.3 \text{ V}.$
 - Measured at $T_{amb} = 25 \, ^{\circ}C$.

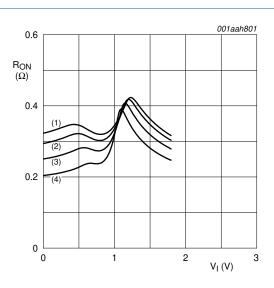
Fig 8. Typical ON resistance as a function of input voltage

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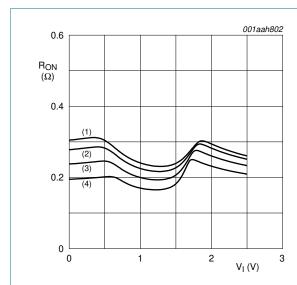
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 9. ON resistance as a function of input voltage; $V_{CC} = 1.5 \text{ V}$



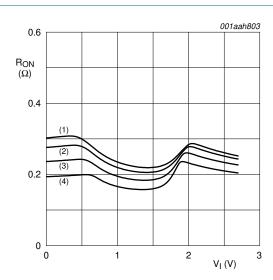
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 10. ON resistance as a function of input voltage; $V_{CC} = 1.8 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C.$
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

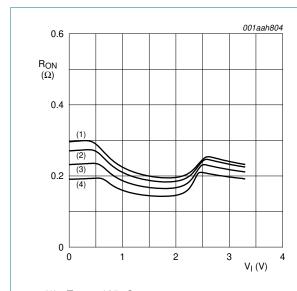
Fig 11. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \,^{\circ}C$.
- (3) $T_{amb} = 25 \,^{\circ}C$.
- (4) $T_{amb} = -40$ °C.

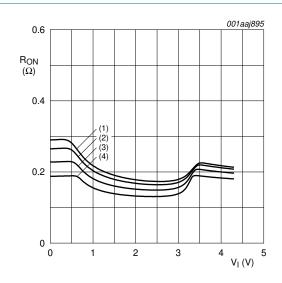
Fig 12. ON resistance as a function of input voltage; $V_{CC} = 2.7 \text{ V}$

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- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 13. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 14. ON resistance as a function of input voltage; $V_{CC} = 4.3 \text{ V}$

12. Dynamic characteristics

Table 9. Dynamic characteristics

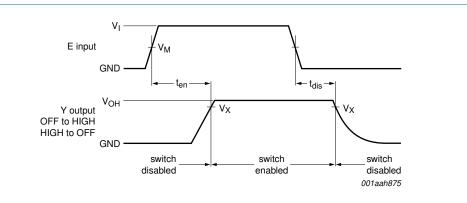
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit Figure 16.

Symbol	Parameter	Conditions	T _{amb} = 25 °C			T _{amb} = -40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	E to Y; see Figure 15							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	35	49	-	53	57	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	28	40	-	43	48	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	20	30	-	32	35	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	18	28	-	30	32	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	18	28	-	30	32	ns
t _{dis}	disable time	E to Y; see Figure 15							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	32	70	-	80	90	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	23	55	-	60	65	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	14	25	-	30	35	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	11	20	-	25	30	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	11	20	-	25	30	ns

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

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12.1 Waveform and test circuits



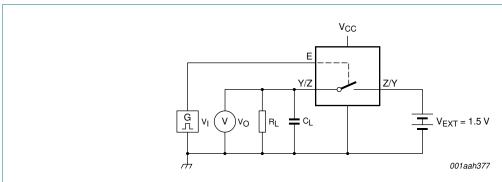
Measurement points are given in Table 10.

Logic level: V_{OH} is the typical output voltage that occurs with the output load.

Fig 15. Enable and disable times

Table 10. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}



Test data is given in Table 11.

Definitions test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 V_{EXT} = External voltage for measuring switching times.

Fig 16. Load circuit for switching times

Table 11. Test data

Supply voltage	Input		Load	
V _{CC}	V _I	t _r , t _f	CL	R _L
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω

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12.2 Additional dynamic characteristics

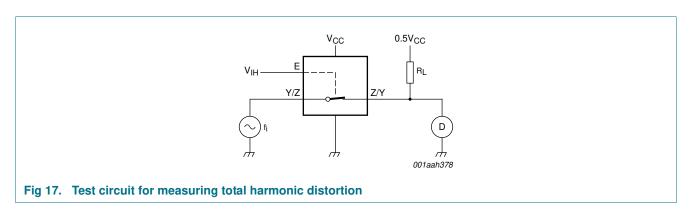
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_l = GND or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

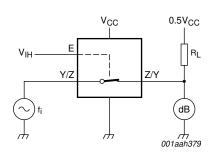
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic	f_i = 20 Hz to 20 kHz; R_L = 32 Ω ; see Figure 17	[1]			
f _(-3dB)	distortion	$V_{CC} = 1.4 \text{ V}; V_I = 1 \text{ V } (p-p)$	-	0.05	-	%
		$V_{CC} = 1.65 \text{ V}; V_I = 1.2 \text{ V (p-p)}$	-	0.03	-	%
		$V_{CC} = 2.3 \text{ V}; V_I = 1.5 \text{ V (p-p)}$	-	0.01	-	%
		$V_{CC} = 2.7 \text{ V}; V_{I} = 2 \text{ V } (p-p)$	-	0.01	-	%
		$V_{CC} = 4.3 \text{ V}; V_{I} = 2 \text{ V } (p-p)$	-	0.01	-	%
f _(-3dB)	–3 dB frequency	$R_L = 50 \Omega$; see Figure 18	[1]			
	response	V _{CC} = 1.4 V to 4.3 V	-	25	-	MHz
$lpha_{iso}$	isolation (OFF-state)	f_i = 100 kHz; R_L = 50 Ω ; see Figure 19	[1]			
		V _{CC} = 1.4 V to 4.3 V	-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 20				
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	0.3	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	0.5	-	V
Q _{inj}	charge injection	f_i = 1 MHz; C_L = 0.1 nF; R_L = 1 M Ω ; V_{gen} = 0 V; R_{gen} = 0 Ω ; see Figure 21				
		V _{CC} = 1.5 V	-	6.5	-	рС
		V _{CC} = 1.8 V	-	6.5	-	рС
		V _{CC} = 2.5 V	-	6.5	-	рС
		$V_{CC} = 3.3 \text{ V}$	-	6.5	-	рС
		V _{CC} = 4.3 V	-	12	-	рС

^[1] f_i is biased at $0.5V_{CC}$.

12.3 Test circuits

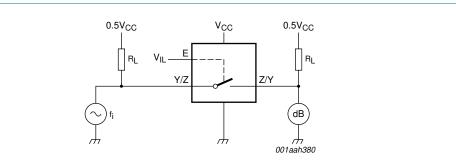


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Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB.

Fig 18. Test circuit for measuring the frequency response when channel is in ON-state



Adjust fi voltage to obtain 0 dBm level at input.

Fig 19. Test circuit for measuring isolation (OFF-state)

NX3V1T66 NXP Semiconductors

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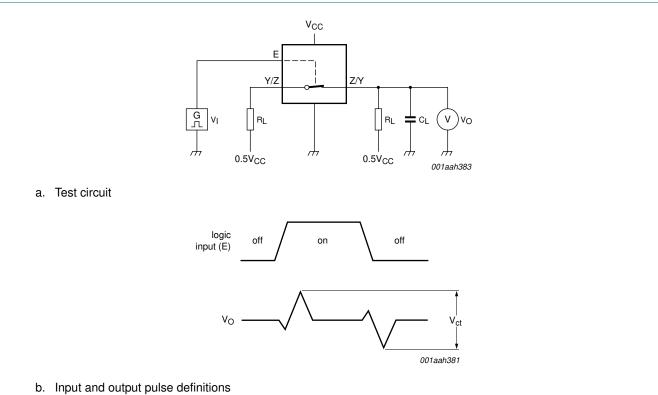
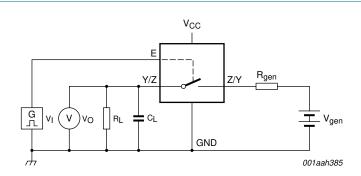
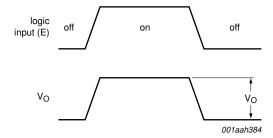


Fig 20. Test circuit for measuring crosstalk voltage between digital inputs and switch

Low-ohmic single-pole single-throw analog switch



a. Test circuit



b. Input and output pulse definitions

Definition: $Q_{inj} = \Delta V_O \times C_L$.

 ΔV_{O} = output voltage variation.

 R_{gen} = generator resistance.

 V_{gen} = generator voltage.

Fig 21. Test circuit for measuring charge injection

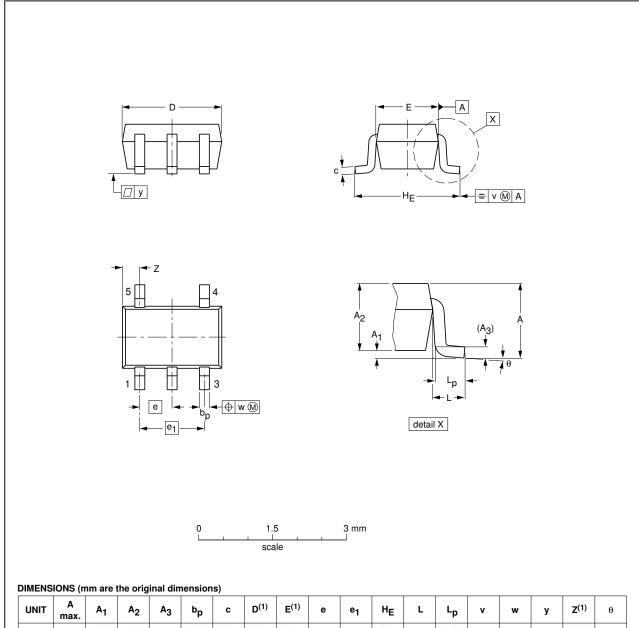
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13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	HE	L	Lp	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.1 0	1.0 0.8	0.15	0.30 0.15	0.25 0.08	2.25 1.85	1.35 1.15	0.65	1.3	2.25 2.0	0.425	0.46 0.21	0.3	0.1	0.1	0.60 0.15	7° 0°

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLI	INE		REFER	EUROPEAN	ISSUE DATE			
VERSION	ON	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT35	53-1		MO-203	SC-88A			-00-09-01 03-02-19	

Fig 22. Package outline SOT353-1 (TSSOP5)

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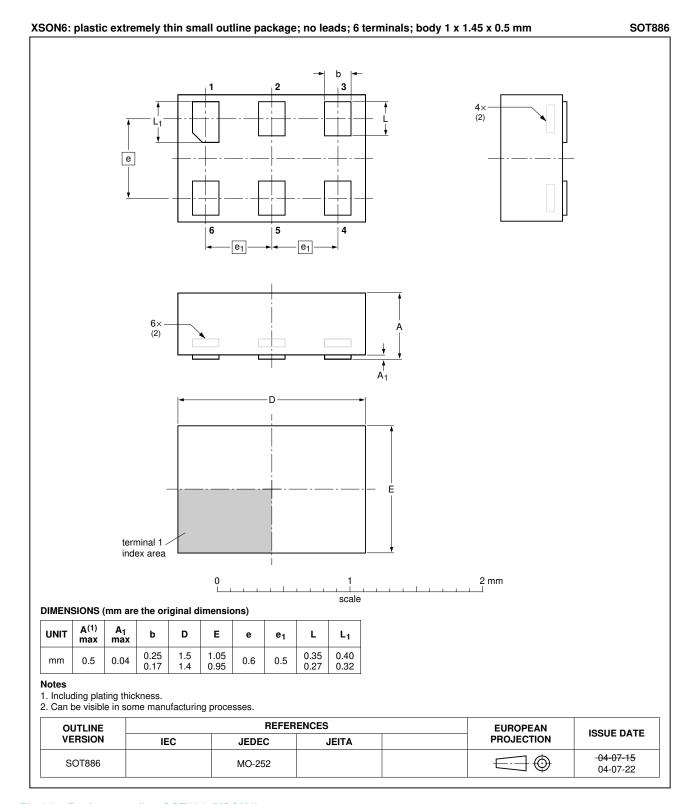


Fig 23. Package outline SOT886 (XSON6)

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14. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant

15. Revision history

Table 14. Revision history

	········			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3V1T66 v.7	20111102	Product data sheet	-	NX3V1T66 v.6
Modifications:	 Legal pages 	s updated		
NX3V1T66 v.6	20101221	Product data sheet	-	NX3V1T66 v.5
NX3V1T66 v.5	20100324	Product data sheet	-	NX3V1T66 v.4
NX3V1T66 v.4	20100202	Product data sheet	-	NX3V1T66 v.3
NX3V1T66 v.3	20090504	Product data sheet	-	NX3V1T66 v.2
NX3V1T66 v.2	20080724	Product data sheet	-	NX3V1T66 v.1
NX3V1T66 v.1	20080327	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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